

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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- 2.7-V and 5-V Performance
- Low-Power Shutdown Mode (LMV324S)
- No Crossover Distortion
- Low Supply Current:
 - LMV321 . . . 130 μ A Typ
 - LMV358 . . . 210 μ A Typ
 - LMV324 . . . 410 μ A Typ
 - LMV324S . . . 410 μ A Typ
- Rail-to-Rail Output Swing
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 1000-V Charged-Device Model (C101)

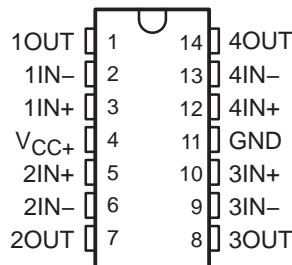
description/ordering information

The LMV321, LMV358, and LMV324/LMV324S are single, dual, and quad low-voltage (2.7 V to 5.5 V), operational amplifiers with rail-to-rail output swing. The LMV324S, which is a variation of the standard LMV324, includes a power-saving shutdown feature that reduces supply current to a maximum of 5 μ A per channel when the amplifiers are not needed. Channels 1 and 2 together are put in shutdown, as are channels 3 and 4. While in shutdown, the outputs actively are pulled low.

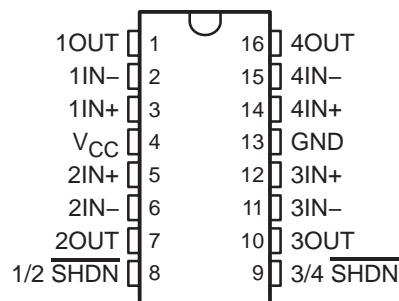
The LMV321, LMV358, LMV324, and LMV324S are the most cost-effective solutions for applications where low-voltage operation, space saving, and low price are needed. These amplifiers were designed specifically for low-voltage (2.7 V to 5 V) operation, with performance specifications meeting or exceeding the venerable LM358 and LM324 devices that operate from 5 V to 30 V. Additional features of the LMV3xx devices are a common-mode input voltage range that includes ground, 1-MHz unity-gain bandwidth, and 1-V/ μ s slew rate.

The LMV321 is available in the ultra-small DCK (SC-70) package, which is approximately one-half the size of the DBV (SOT-23) package. This package saves space on printed circuit boards and enables the design of small portable electronic devices. It also allows the designer to place the device closer to the signal source to reduce noise pickup and increase signal integrity.

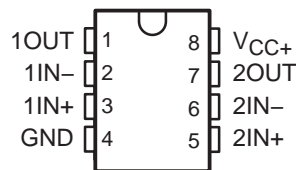
LMV324 . . . D (SOIC) OR PW (TSSOP) PACKAGE
(TOP VIEW)



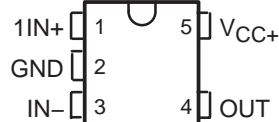
LMV324S . . . D (SOIC) OR PW (TSSOP) PACKAGE
(TOP VIEW)



LMV358 . . . D (SOIC), DDU (VSSOP),
DGK (MSOP), OR PW (TSSOP) PACKAGE
(TOP VIEW)



LMV321 . . . DBV (SOT-23) OR DCK (SC-70) PACKAGE
(TOP VIEW)



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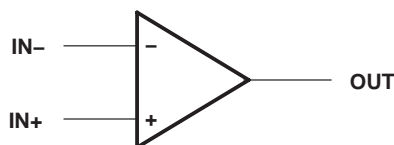
ORDERING INFORMATION

T _A		PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
-40°C to 85°C	Single	SC-70 (DCK)	Reel of 3000	LMV321IDCKR	R3_
			Reel of 250	LMV321IDCKT	
		SOT23-5 (DBV)	Reel of 3000	LMV321IDBVR	RC1_
			Reel of 250	LMV321IDBVT	
	Dual	MSOP/VSSOP (DGK)	Reel of 2500	LMV358IDGKR	R5R
			Tube of 75	LMV358ID	MV358I
		SOIC (D)	Reel of 2500	LMV358IDR	
			TSSOP (PW)	Tube of 150	LMV358IPW
		Reel of 2000		LMV358IPWR	
		VSSOP (DDU)	Reel of 3000	LMV358IDDUR	RA56
	Quad	SOIC (D)	Tube of 50	LMV324ID	LMV324I
			Reel of 2500	LMV324IDR	
			Tube of 40	LMV324SID	LMV324SI
			Reel of 2500	LMV324SIDR	
TSSOP (PW)		Reel of 2000	LMV324IPWR	MV324I	
			LMV324SIPWR	MV324SI	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

‡ DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

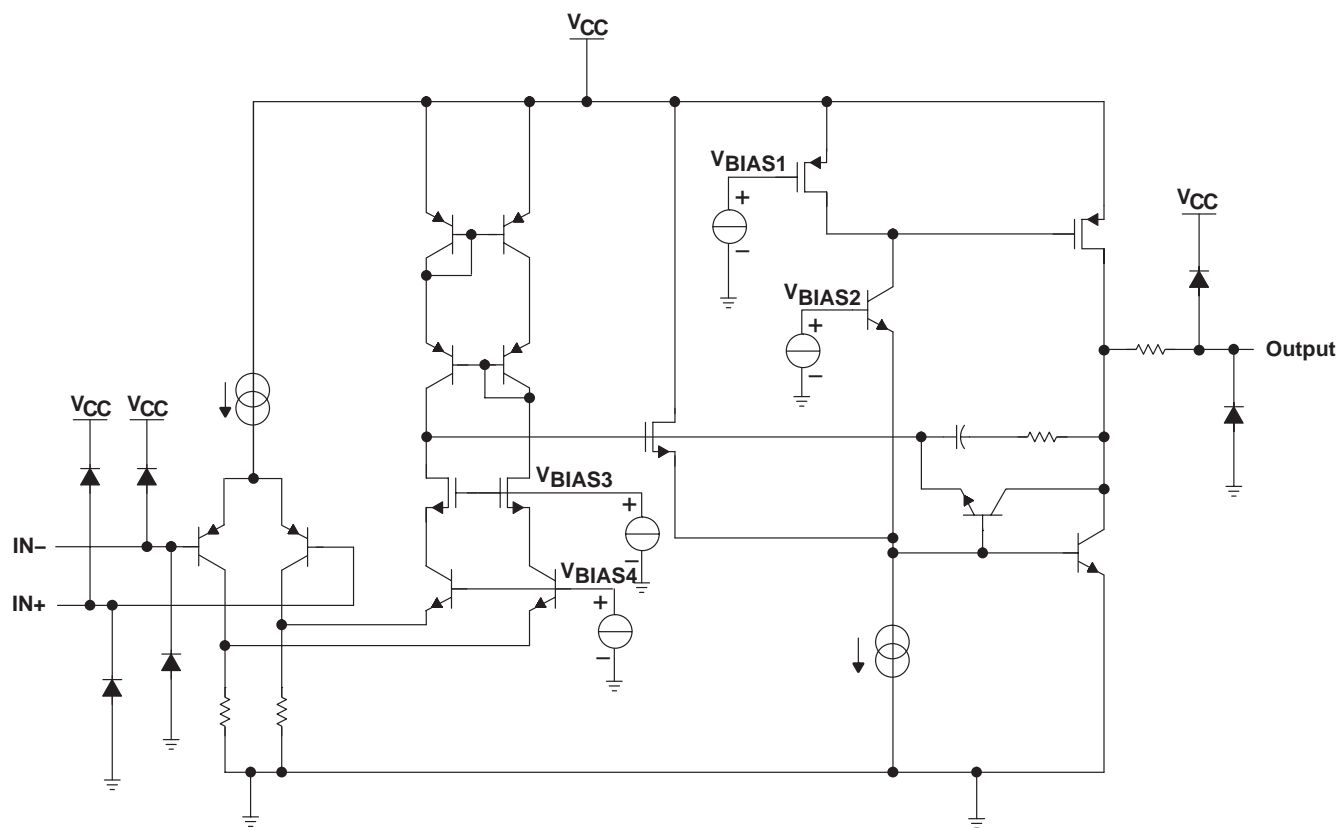
symbol (each amplifier)



LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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LMV324 simplified schematic



LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1)	5.5 V
Differential input voltage, V_{ID} (see Note 2)	± 5.5 V
Input voltage, V_I (either input)	0 to 5.5 V
Duration of output short circuit (one amplifier) to ground at (or below) $T_A = 25^\circ\text{C}$, $V_{CC} \leq 5.5$ V (see Note 3)	Unlimited
Package thermal impedance, θ_{JA} (see Notes 4 and 5):	
D (8-pin) package	97°C/W
D (14-pin) package	86°C/W
D (16-pin) package	73°C/W
DBV (5-pin) package	206°C/W
DCK (5-pin) package	252°C/W
DDU (8-pin) package	TBD°C/W
DGK (8-pin) package	172°C/W
PW (8-pin) package	149°C/W
PW (14-pin) package	113°C/W
PW (16-pin) package	108°C/W
Operating virtual junction temperature, T_J	150°C
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
 2. Differential voltages are at $IN+$ with respect to $IN-$.
 3. Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
 4. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Selecting the maximum of 150°C can affect reliability.
 5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 6)

		MIN	MAX	UNIT
V_{CC}	Supply voltage (single-supply operation)	2.7	5.5	V
V_{IH}	Amplifier turnon voltage level (LMV324S)‡	$V_{CC} = 2.7$ V	1.7	V
		$V_{CC} = 5$ V	3.5	
V_{IL}	Amplifier turnoff voltage level (LMV324S)	$V_{CC} = 2.7$ V	0.7	V
		$V_{CC} = 5$ V	1.5	
T_A	Operating free-air temperature	-40	85	°C

‡ V_{IH} should not be allowed to exceed V_{CC} .

NOTE 6: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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electrical characteristics at $T_A = 25^\circ\text{C}$ and $V_{CC+} = 2.7\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{IO}	Input offset voltage			1.7	7	mV
$\alpha_{V_{IO}}$	Average temperature coefficient of input offset voltage			5		$\mu\text{V}/^\circ\text{C}$
I_{IB}	Input bias current			11	250	nA
I_{IO}	Input offset current			5	50	nA
CMRR	Common-mode rejection ratio	$V_{CM} = 0$ to 1.7 V	50	63		dB
k_{SVR}	Supply-voltage rejection ratio	$V_{CC} = 2.7\text{ V}$ to 5 V , $V_O = 1\text{ V}$	50	60		dB
V_{ICR}	Common-mode input voltage range	CMRR $\geq 50\text{ dB}$	0 to 1.7	-0.2 to 1.9		V
Output swing		$R_L = 10\text{ k}\Omega$ to 1.35 V	High level	$V_{CC}-100$	$V_{CC}-10$	mV
			Low level		60	
I_{CC}	Supply current	LMV321I		80	170	μA
		LMV358I (both amplifiers)		140	340	
		LMV324I/LMV324SI (all four amplifiers)		260	680	
B_1	Unity-gain bandwidth	$C_L = 200\text{ pF}$		1		MHz
Φ_m	Phase margin			60		deg
G_m	Gain margin			10		dB
V_n	Equivalent input noise voltage	$f = 1\text{ kHz}$		46		$\text{nV}/\sqrt{\text{Hz}}$
I_n	Equivalent input noise current	$f = 1\text{ kHz}$		0.17		$\text{pA}/\sqrt{\text{Hz}}$

shutdown characteristics (LMV324S) at $T_A = 25^\circ\text{C}$ and $V_{CC+} = 2.7\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$I_{CC(\text{SHDN})}$	Supply current in shutdown mode (per channel)	$\overline{\text{SHDN}} \leq 0.6\text{ V}$			5	μA
$t_{(\text{on})}$	Amplifier turnon time	$A_V = 1$, $R_L = \text{Open}$ (measured at 50% point)		2		μs
$t_{(\text{off})}$	Amplifier turnoff time	$A_V = 1$, $R_L = \text{Open}$ (measured at 50% point)		40		ns

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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electrical characteristics at specified free-air temperature range, $V_{CC+} = 5\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT	
V_{IO}	Input offset voltage		25°C		1.7	7	mV	
			-40°C to 85°C			9		
$\alpha_{V_{IO}}$	Average temperature coefficient of input offset voltage		25°C		5		$\mu\text{V}/^\circ\text{C}$	
I_{IB}	Input bias current		25°C		15	250	nA	
			-40°C to 85°C			500		
I_{IO}	Input offset current		25°C		5	50	nA	
			-40°C to 85°C			150		
CMRR	Common-mode rejection ratio	$V_{CM} = 0\text{ to }4\text{ V}$	25°C	50	65		dB	
k_{SVR}	Supply-voltage rejection ratio	$V_{CC} = 2.7\text{ V to }5\text{ V}$, $V_O = 1\text{ V}$, $V_{CM} = 1\text{ V}$	25°C	50	60		dB	
V_{ICR}	Common-mode input voltage range	$CMMR \geq 50\text{ dB}$	25°C	0 to 4	-0.2 to 4.2		V	
Output swing		$R_L = 2\text{ k}\Omega\text{ to }2.5\text{ V}$	High level	25°C	$V_{CC}-300$	$V_{CC}-40$	mV	
				-40°C to 85°C	$V_{CC}-400$			
			Low level	25°C		120		300
				-40°C to 85°C				400
		$R_L = 10\text{ k}\Omega\text{ to }2.5\text{ V}$	High level	25°C	$V_{CC}-100$	$V_{CC}-10$		
				-40°C to 85°C	$V_{CC}-200$			
Low level	25°C		65	180				
	-40°C to 85°C			280				
A_{VD}	Large-signal differential voltage gain	$R_L = 2\text{ k}\Omega$	25°C	15	100	V/mV		
			-40°C to 85°C	10				
I_{OS}	Output short-circuit current	Sourcing, $V_O = 0\text{ V}$	25°C	5	60	mA		
		Sinking, $V_O = 5\text{ V}$		10	160			
I_{CC}	Supply current		LMV321I	25°C	130	250	μA	
				-40°C to 85°C				350
			LMV358I (both amplifiers)	25°C	210	440		
				-40°C to 85°C				615
			LMV324I/LMV324SI (all four amplifiers)	25°C	410	830		
				-40°C to 85°C				1160
B_1	Unity-gain bandwidth	$C_L = 200\text{ pF}$	25°C		1	MHz		
ϕ_m	Phase margin		25°C		60	deg		
G_m	Gain margin		25°C		10	dB		
V_n	Equivalent input noise voltage	$f = 1\text{ kHz}$	25°C		39	$\text{nV}/\sqrt{\text{Hz}}$		
I_n	Equivalent input noise current	$f = 1\text{ kHz}$	25°C		0.21	$\text{pA}/\sqrt{\text{Hz}}$		
SR	Slew rate		25°C		1	$\text{V}/\mu\text{s}$		

shutdown characteristics (LMV324S) at $T_A = 25^\circ\text{C}$ and $V_{CC+} = 5\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
$I_{CC}(\text{SHDN})$	Supply current in shutdown mode (per channel)	$\overline{\text{SHDN}} \leq 0.6\text{ V}$	-40°C to 85°C			5	μA
$t_{(\text{on})}$	Amplifier turnon time	$A_V = 1$, $R_L = \text{Open}$ (measured at 50% point)			2		μs
$t_{(\text{off})}$	Amplifier turnoff time	$A_V = 1$, $R_L = \text{Open}$ (measured at 50% point)			40		ns



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TYPICAL CHARACTERISTICS

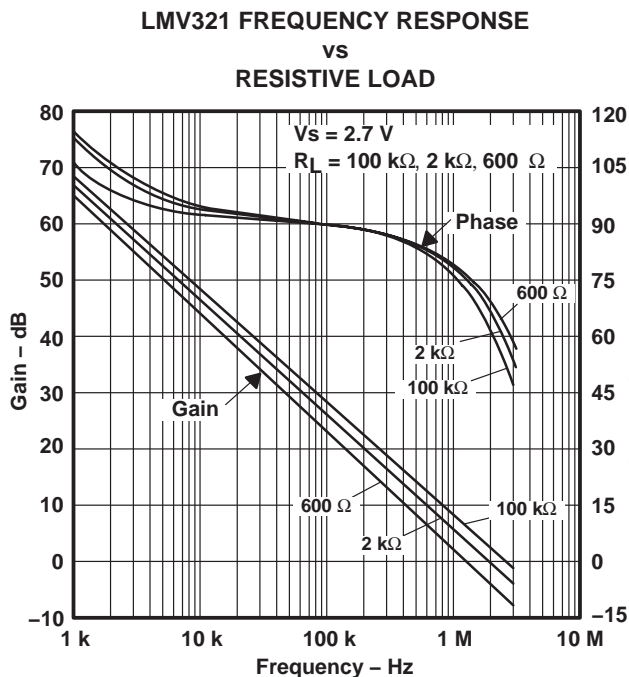


Figure 1

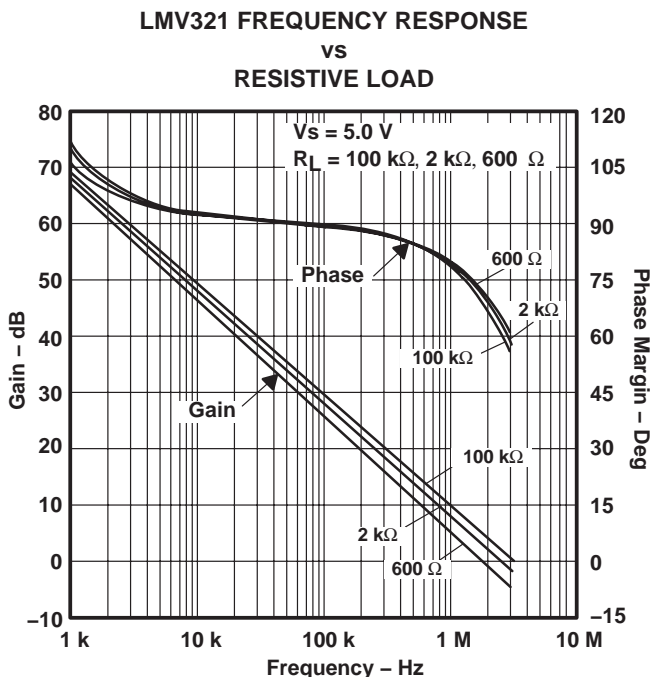


Figure 2

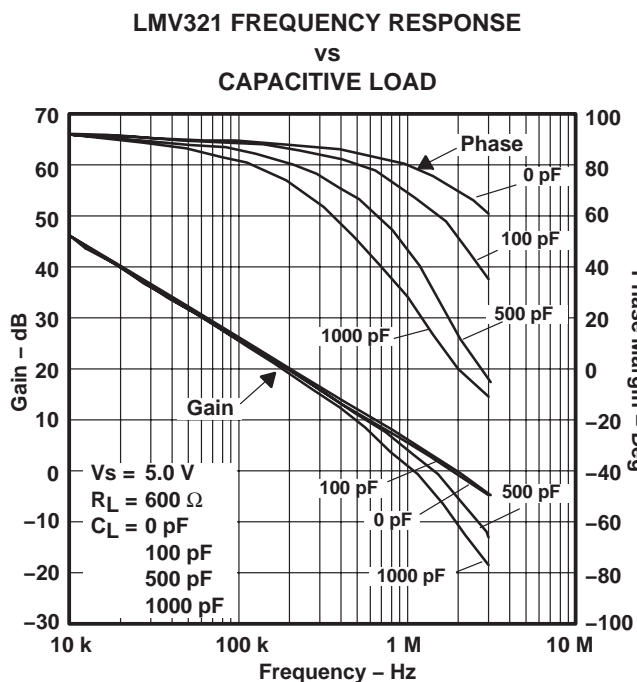


Figure 3

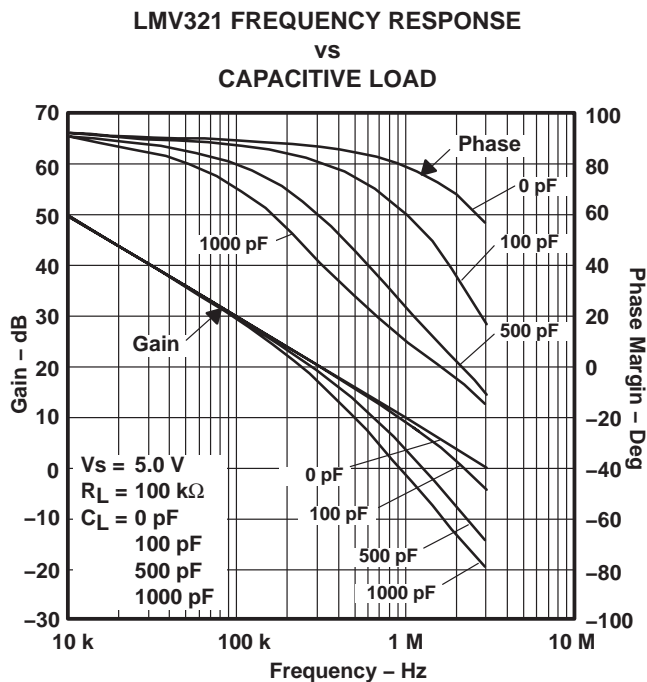


Figure 4



LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

LMV321 FREQUENCY RESPONSE
VS
TEMPERATURE

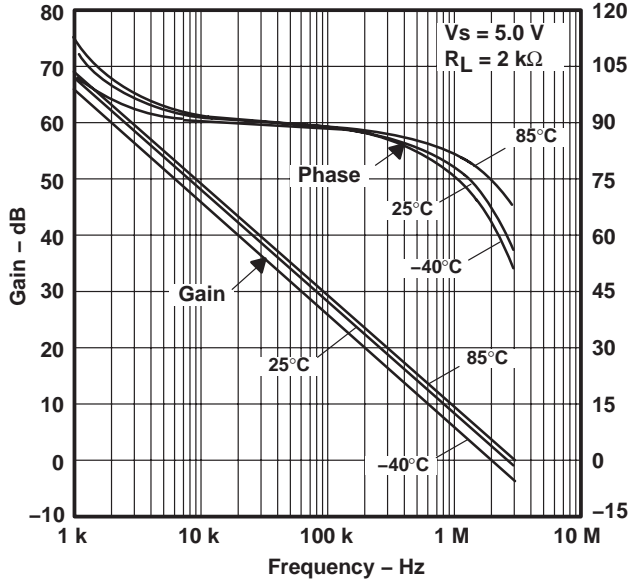


Figure 5

STABILITY
VS
CAPACITIVE LOAD

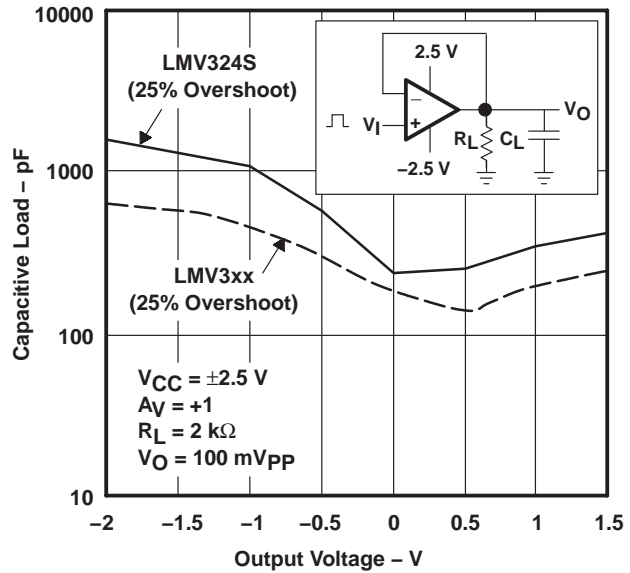


Figure 6

STABILITY
VS
CAPACITIVE LOAD

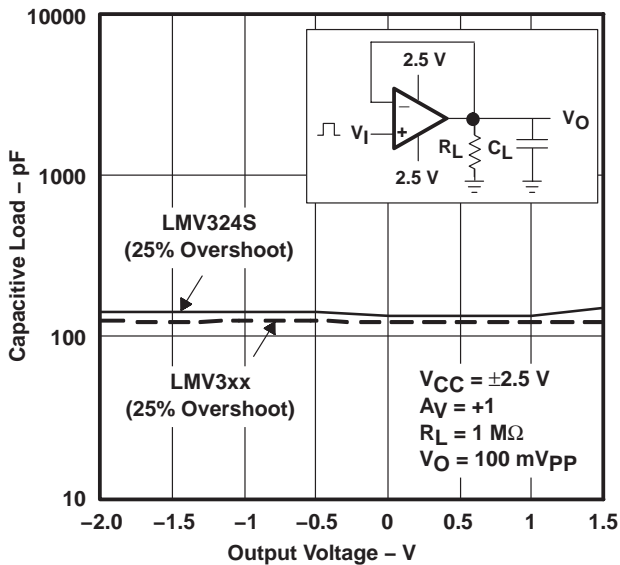


Figure 7

STABILITY
VS
CAPACITIVE LOAD

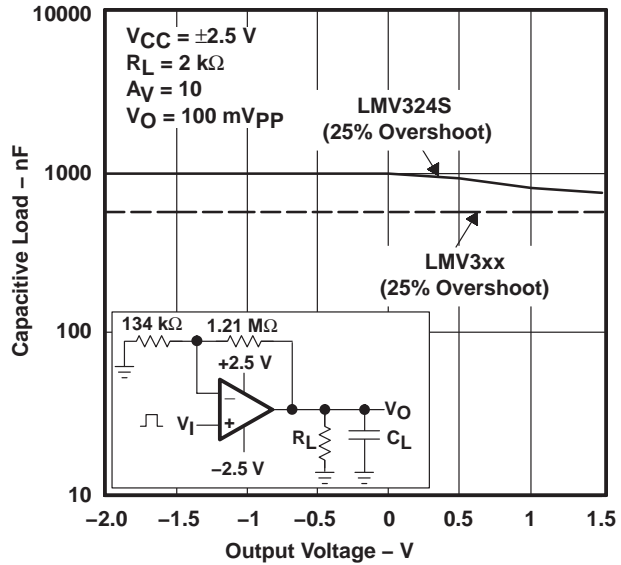


Figure 8

TYPICAL CHARACTERISTICS

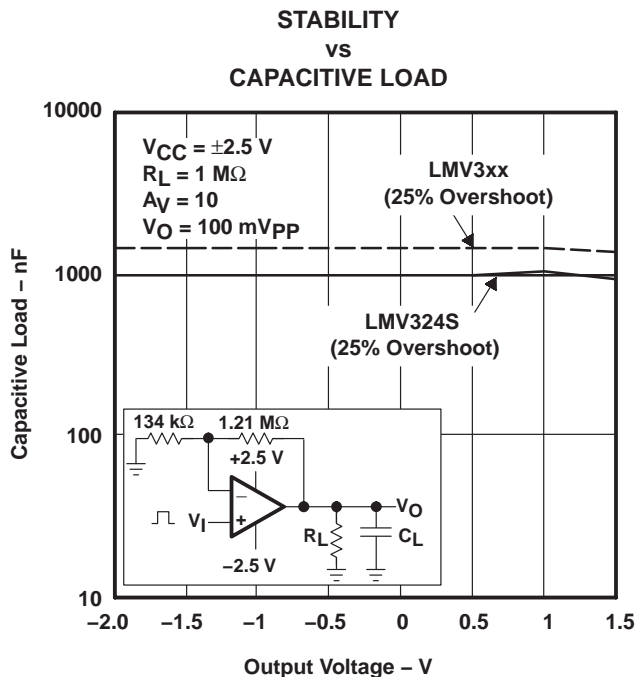


Figure 9

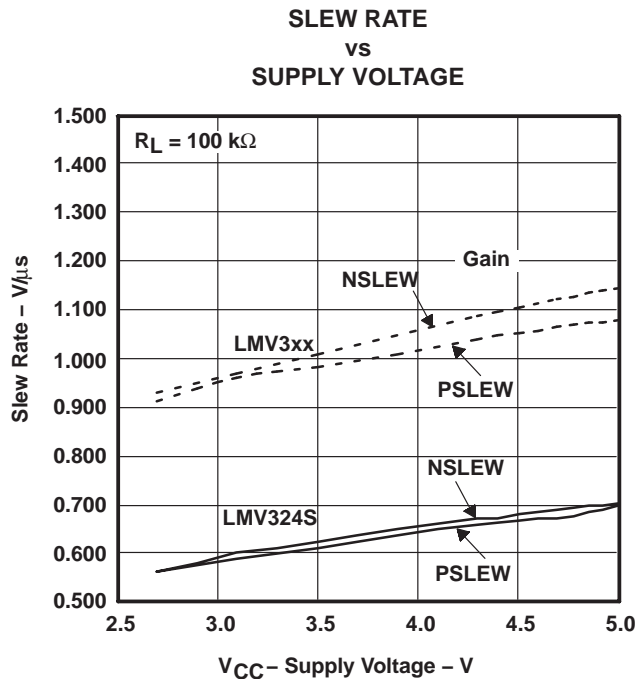


Figure 10

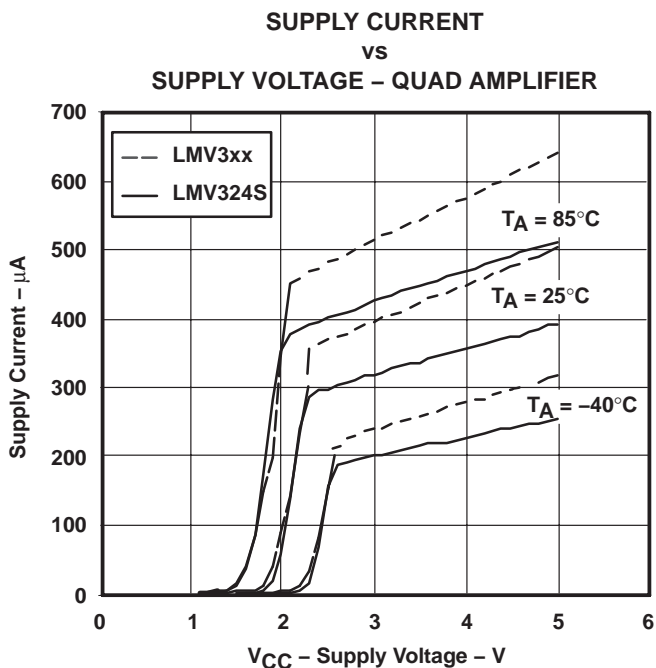


Figure 11

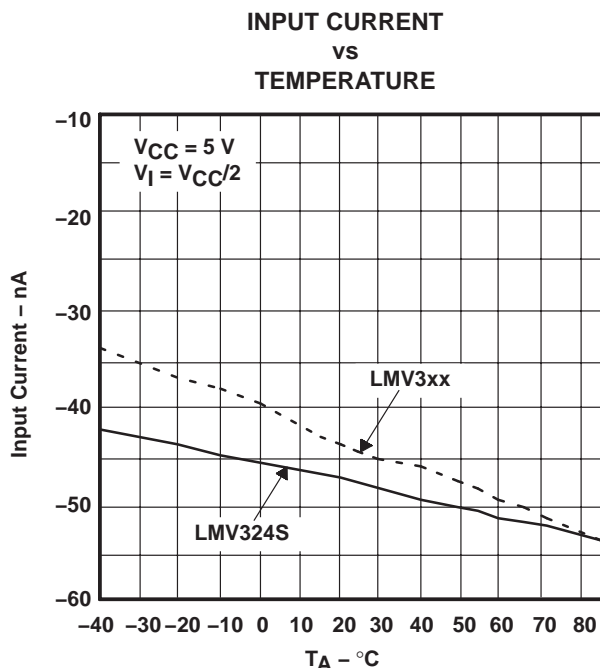
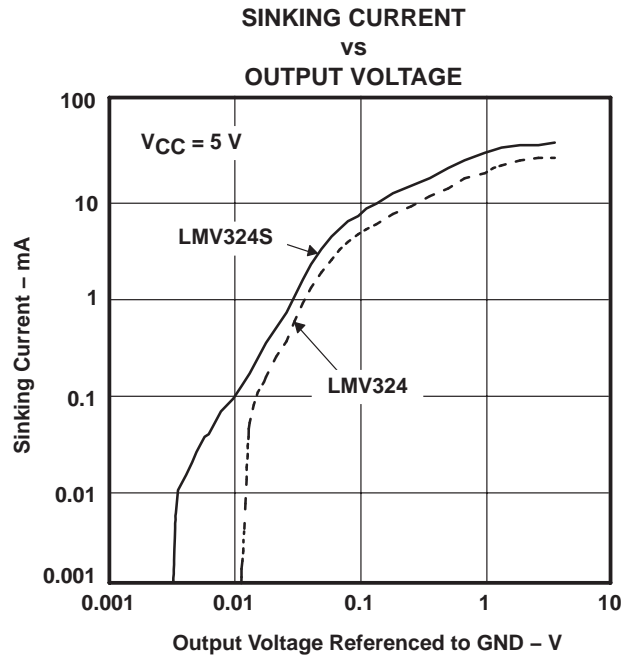
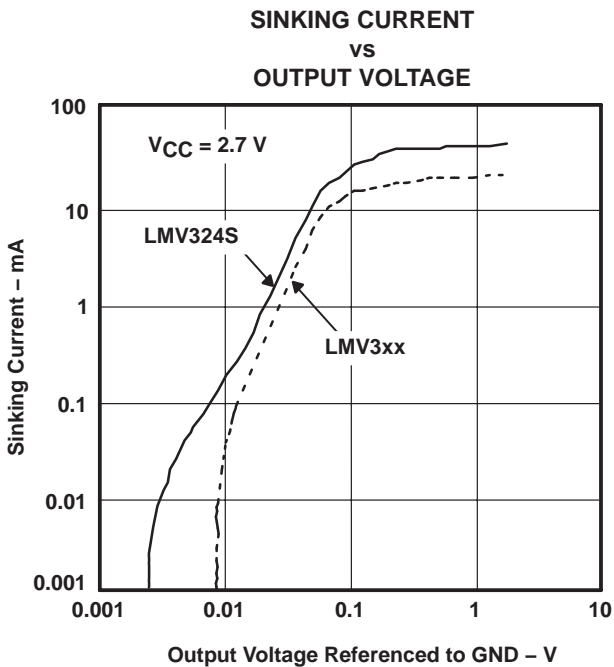
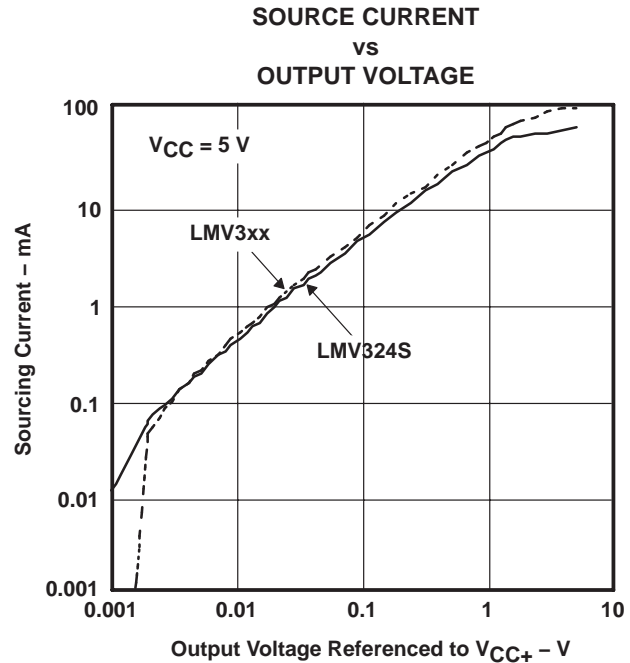
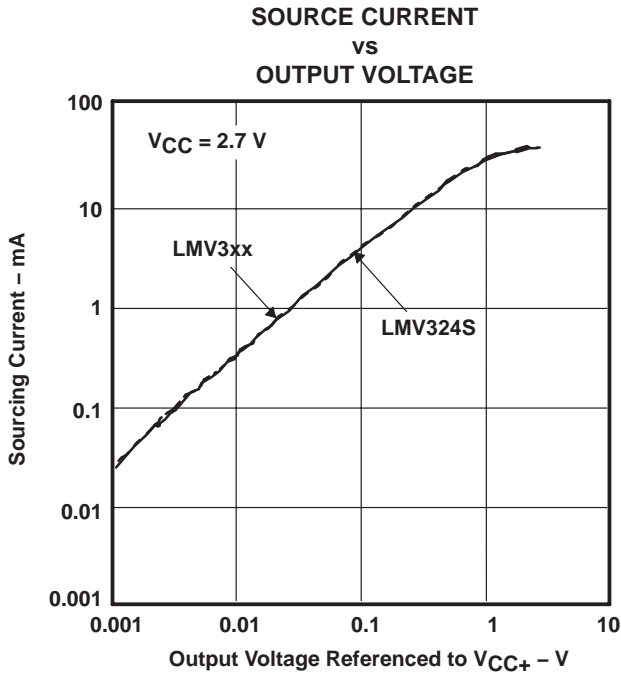


Figure 12

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS



LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

SHORT-CIRCUIT CURRENT
vs
TEMPERATURE

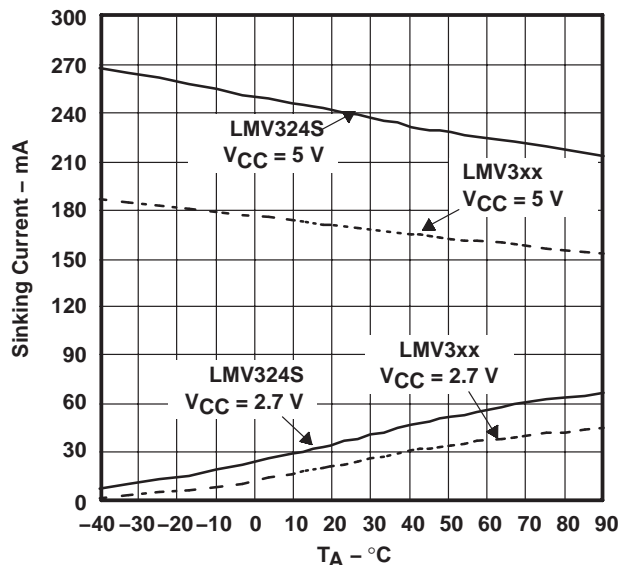


Figure 17

SHORT-CIRCUIT CURRENT
vs
TEMPERATURE

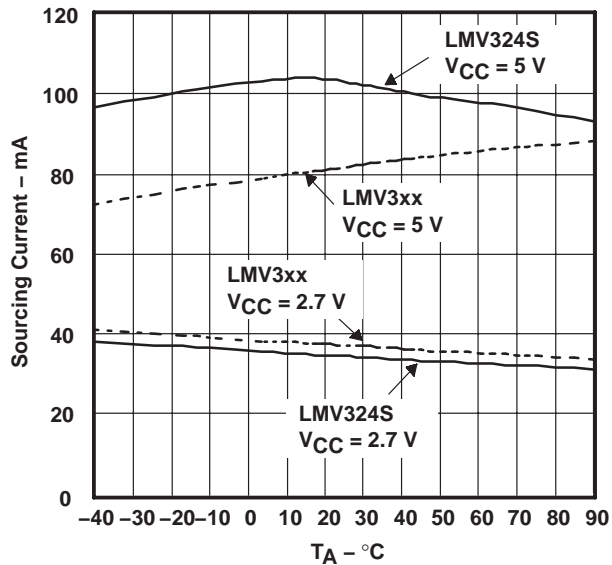


Figure 18

-k_{SVR}
vs
FREQUENCY

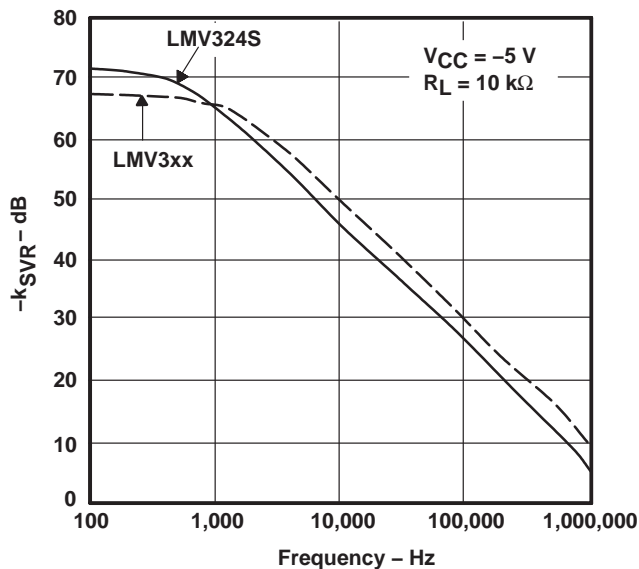


Figure 19

+k_{SVR}
vs
FREQUENCY

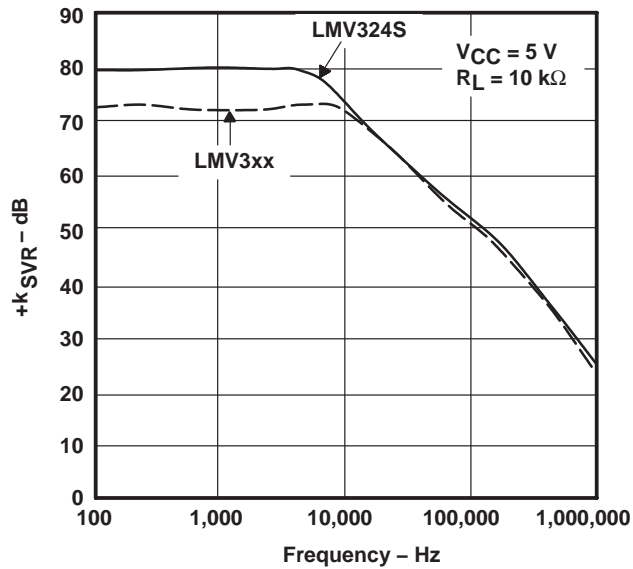


Figure 20

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

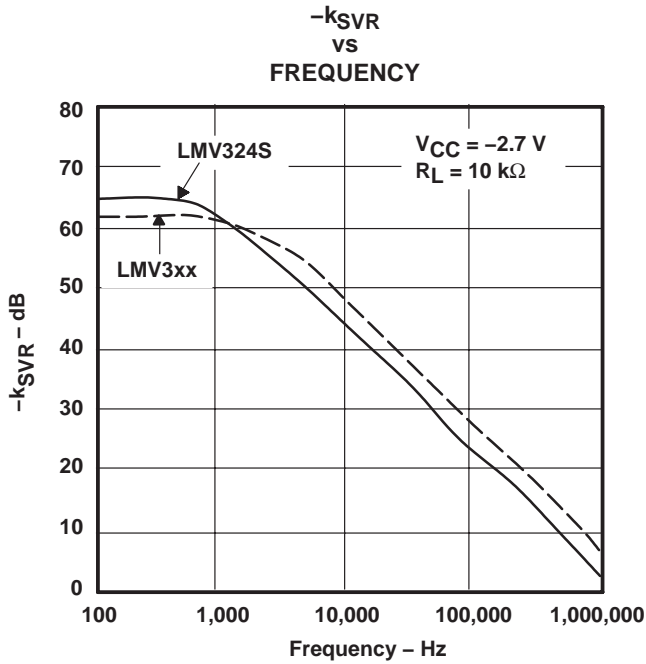


Figure 21

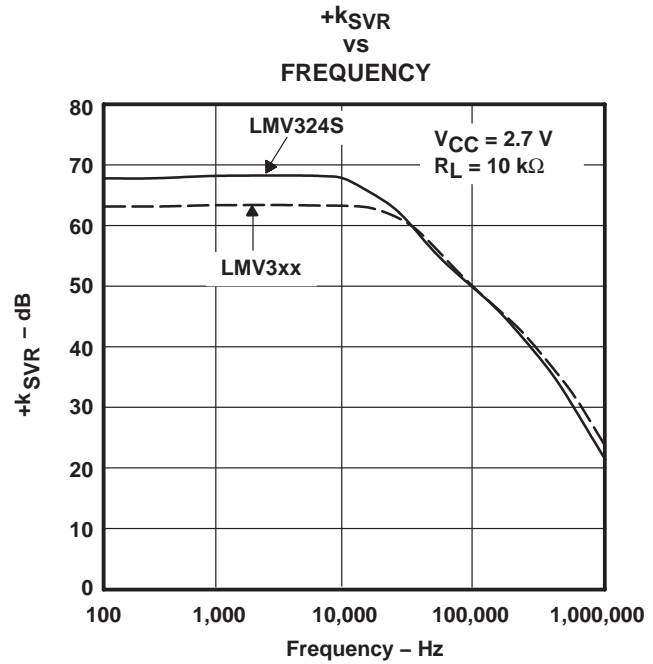


Figure 22

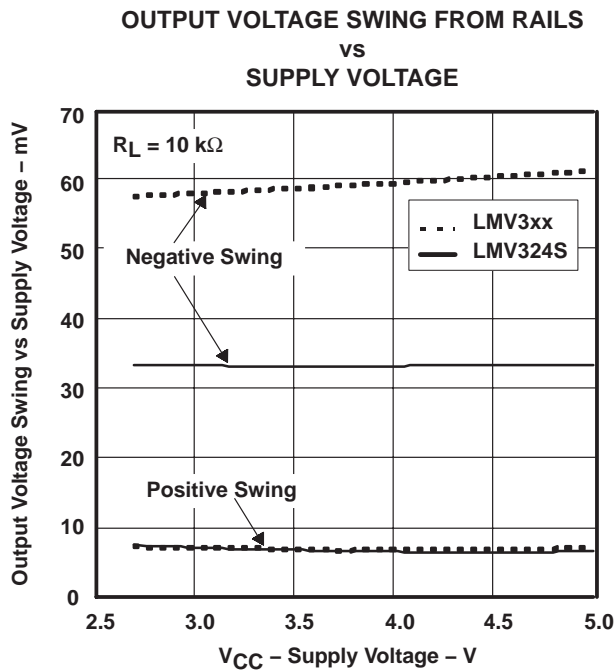


Figure 23

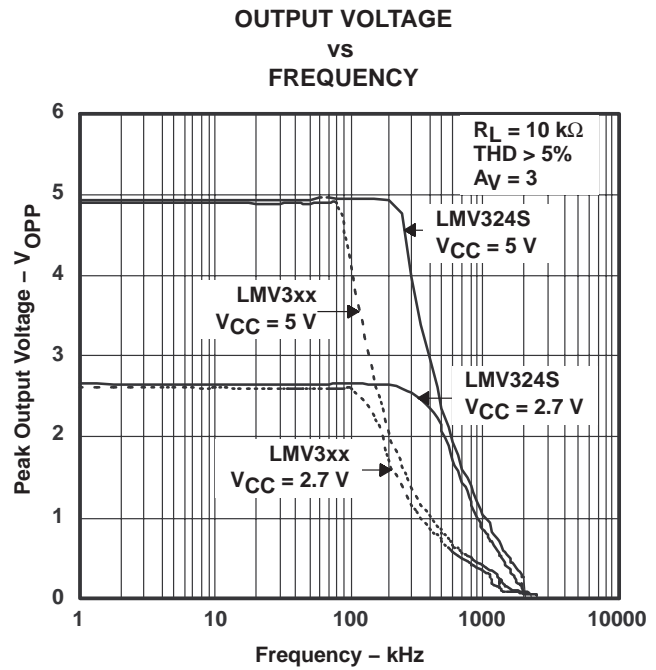


Figure 24

TYPICAL CHARACTERISTICS

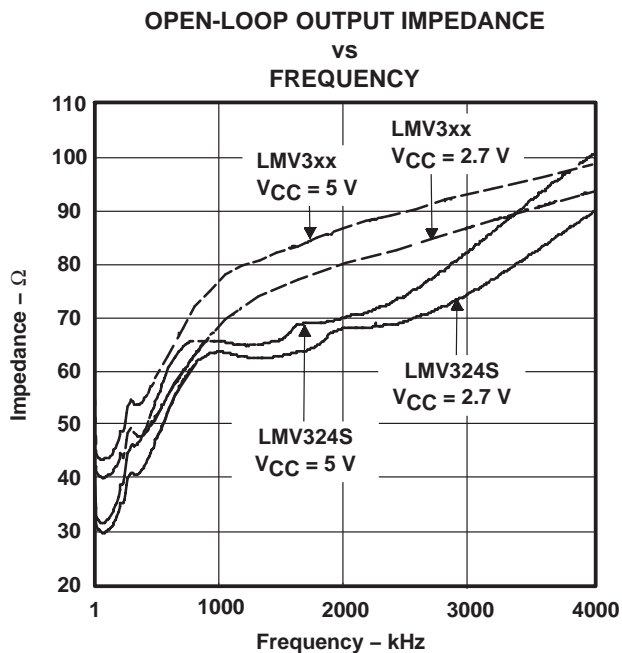


Figure 25

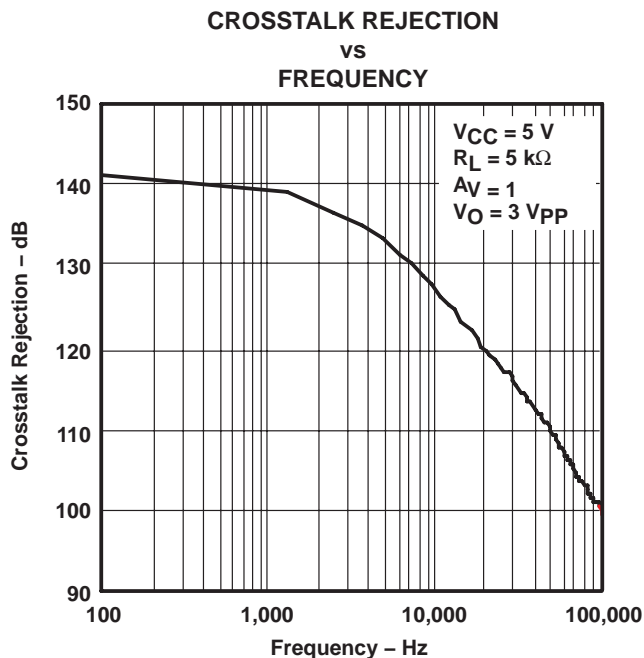


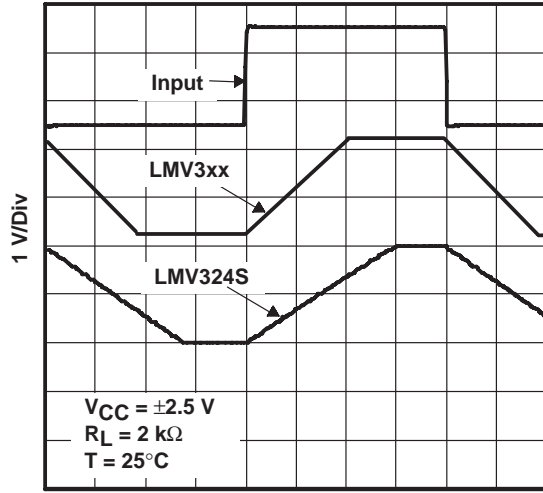
Figure 26

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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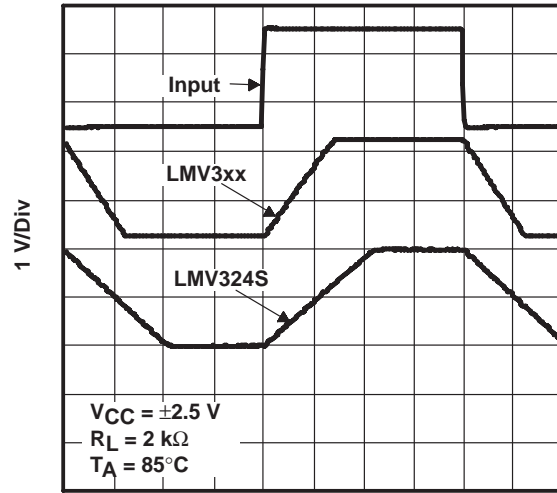
TYPICAL CHARACTERISTICS

NONINVERTING LARGE-SIGNAL PULSE RESPONSE



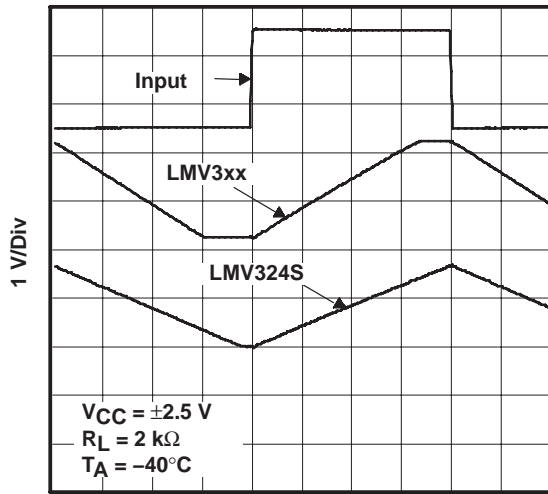
1 $\mu\text{s}/\text{Div}$
Figure 27

NONINVERTING LARGE-SIGNAL PULSE RESPONSE



1 $\mu\text{s}/\text{Div}$
Figure 28

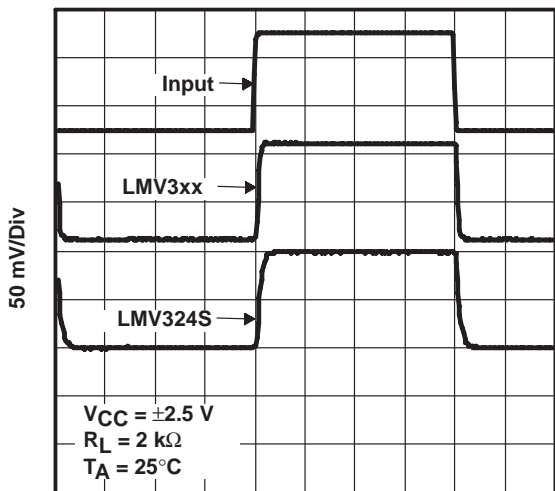
NONINVERTING LARGE-SIGNAL PULSE RESPONSE



1 $\mu\text{s}/\text{Div}$
Figure 29

TYPICAL CHARACTERISTICS

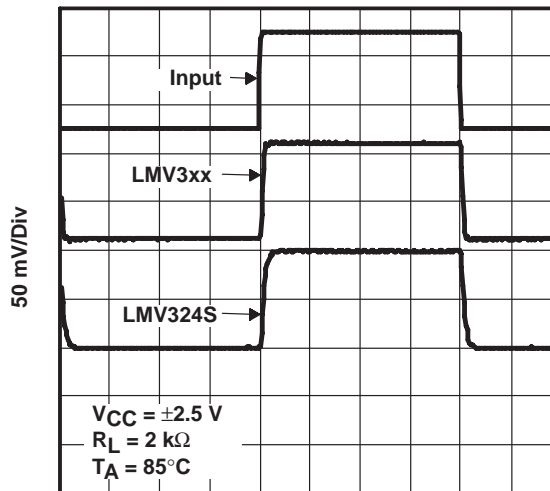
NONINVERTING SMALL-SIGNAL
 PULSE RESPONSE



1 $\mu\text{s}/\text{Div}$

Figure 30

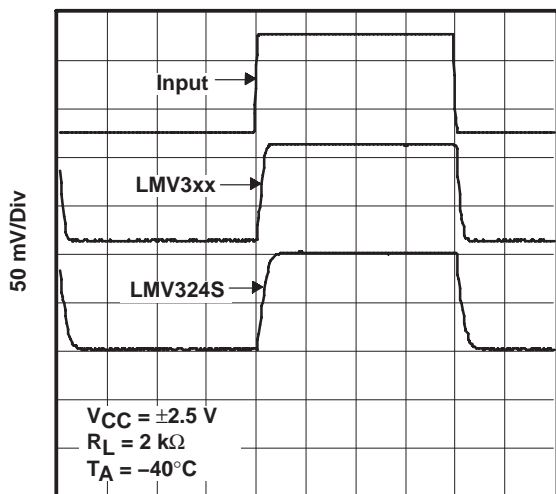
NONINVERTING SMALL-SIGNAL
 PULSE RESPONSE



1 $\mu\text{s}/\text{Div}$

Figure 31

NONINVERTING SMALL-SIGNAL
 PULSE RESPONSE



1 $\mu\text{s}/\text{Div}$

Figure 32

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS2630 – AUGUST 1999 – REVISED MAY 2004

TYPICAL CHARACTERISTICS

INVERTING LARGE-SIGNAL PULSE RESPONSE

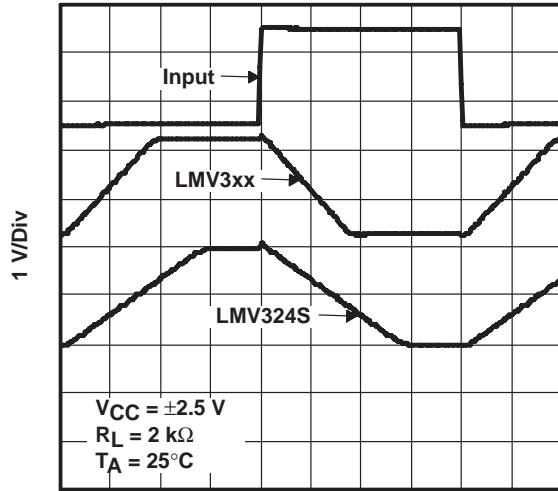


Figure 33

INVERTING LARGE-SIGNAL PULSE RESPONSE

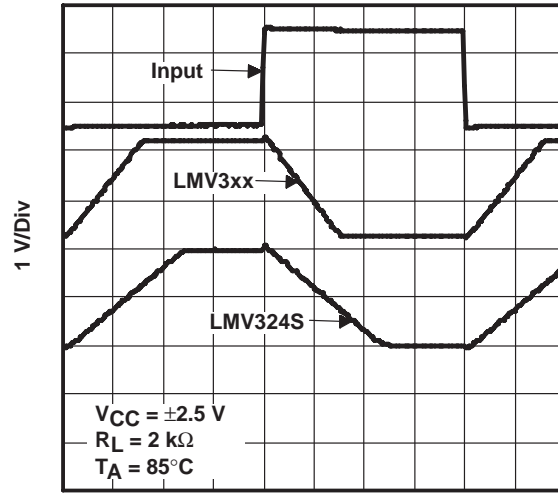


Figure 34

INVERTING LARGE-SIGNAL PULSE RESPONSE

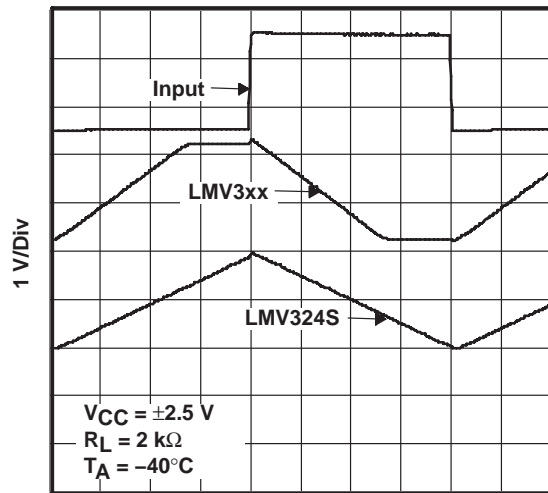
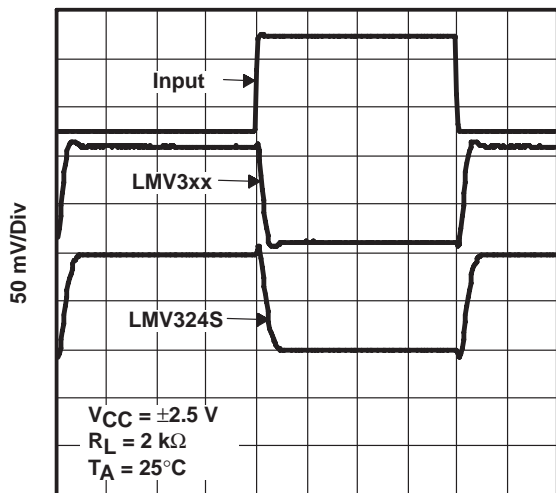


Figure 35

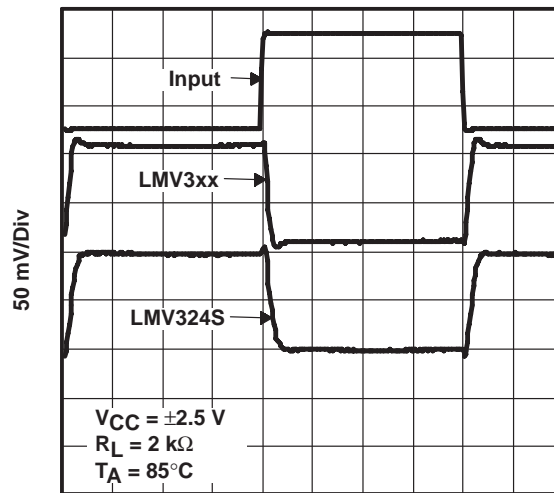
TYPICAL CHARACTERISTICS

INVERTING SMALL-SIGNAL
PULSE RESPONSE



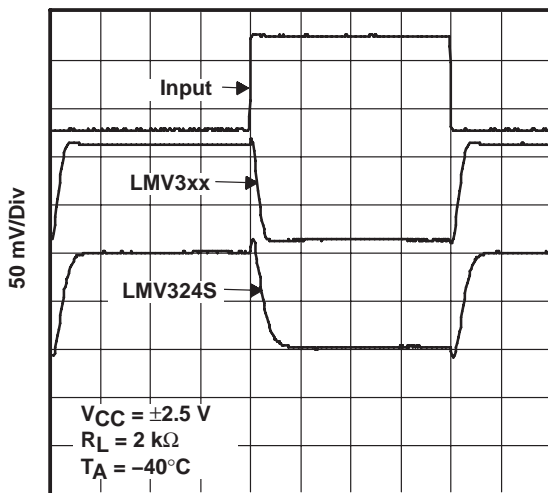
1 $\mu\text{s/Div}$
Figure 36

INVERTING SMALL-SIGNAL
PULSE RESPONSE



1 $\mu\text{s/Div}$
Figure 37

INVERTING SMALL-SIGNAL
PULSE RESPONSE



1 $\mu\text{s/Div}$
Figure 38

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

INPUT CURRENT NOISE
vs
FREQUENCY

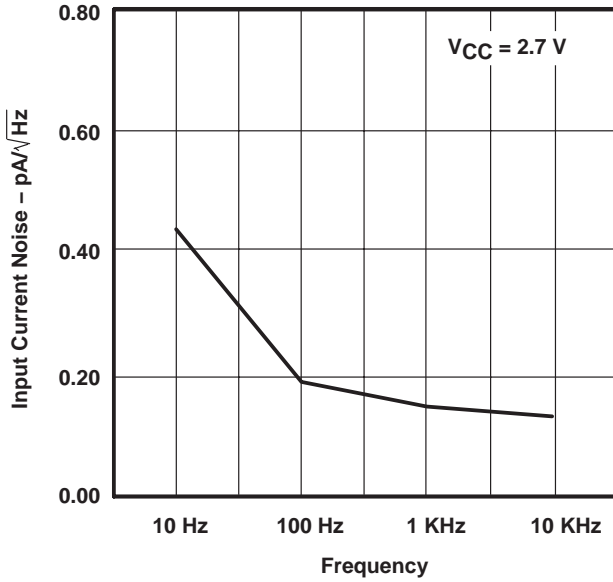


Figure 39

INPUT CURRENT NOISE
vs
FREQUENCY

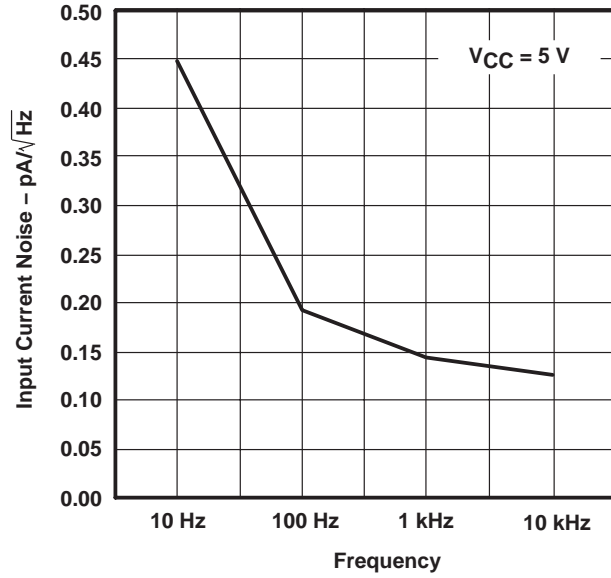


Figure 40

INPUT VOLTAGE NOISE
vs
FREQUENCY

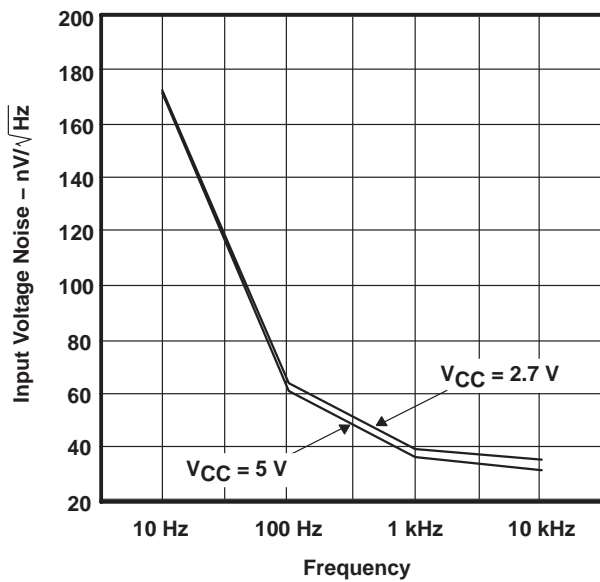


Figure 41



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LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

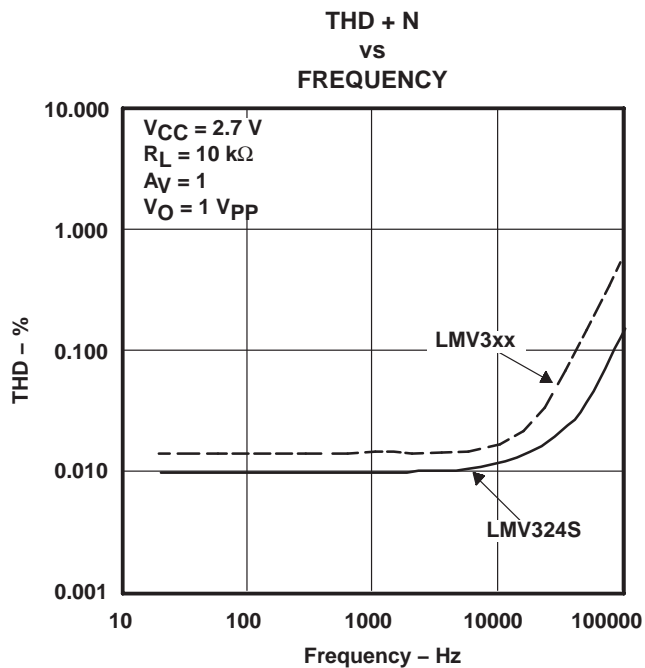


Figure 42

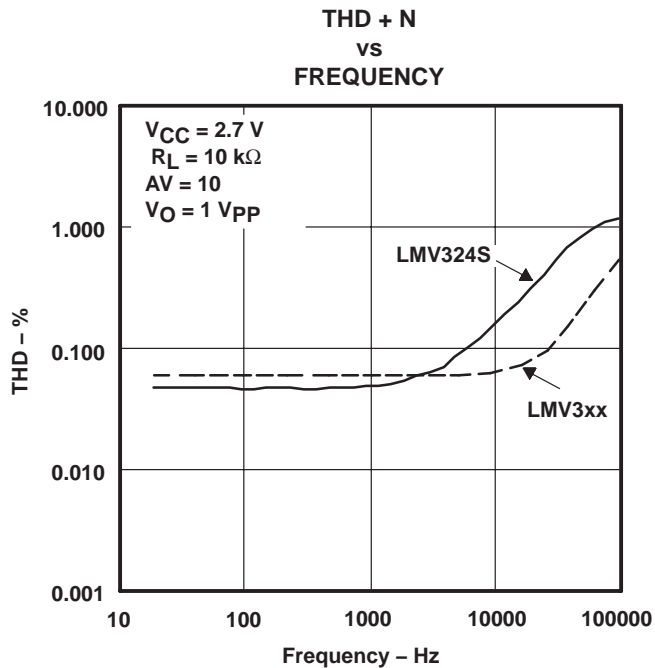


Figure 43

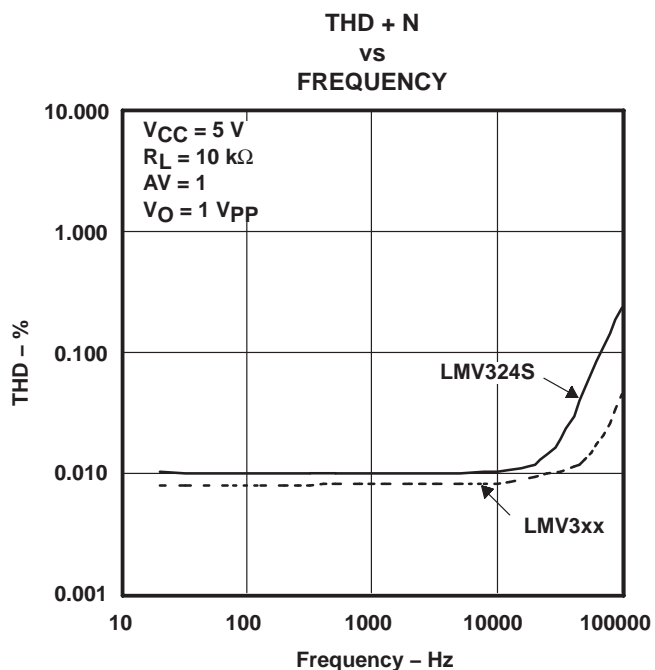


Figure 44

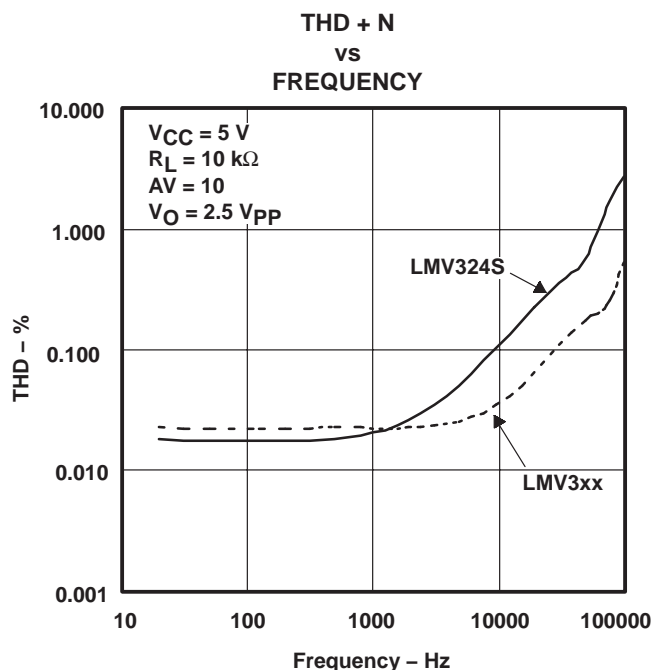
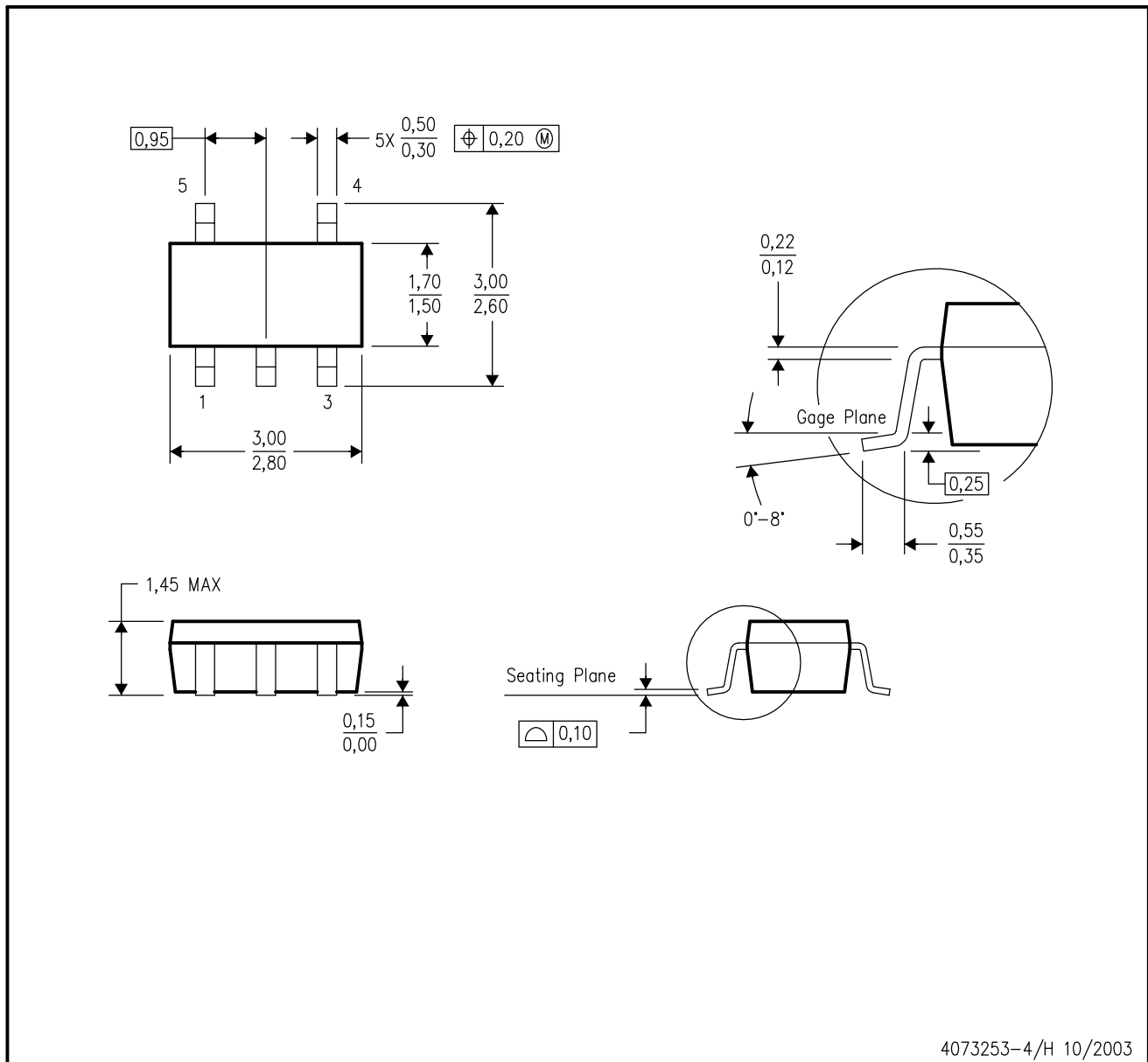


Figure 45

DBV (R-PDSO-G5)

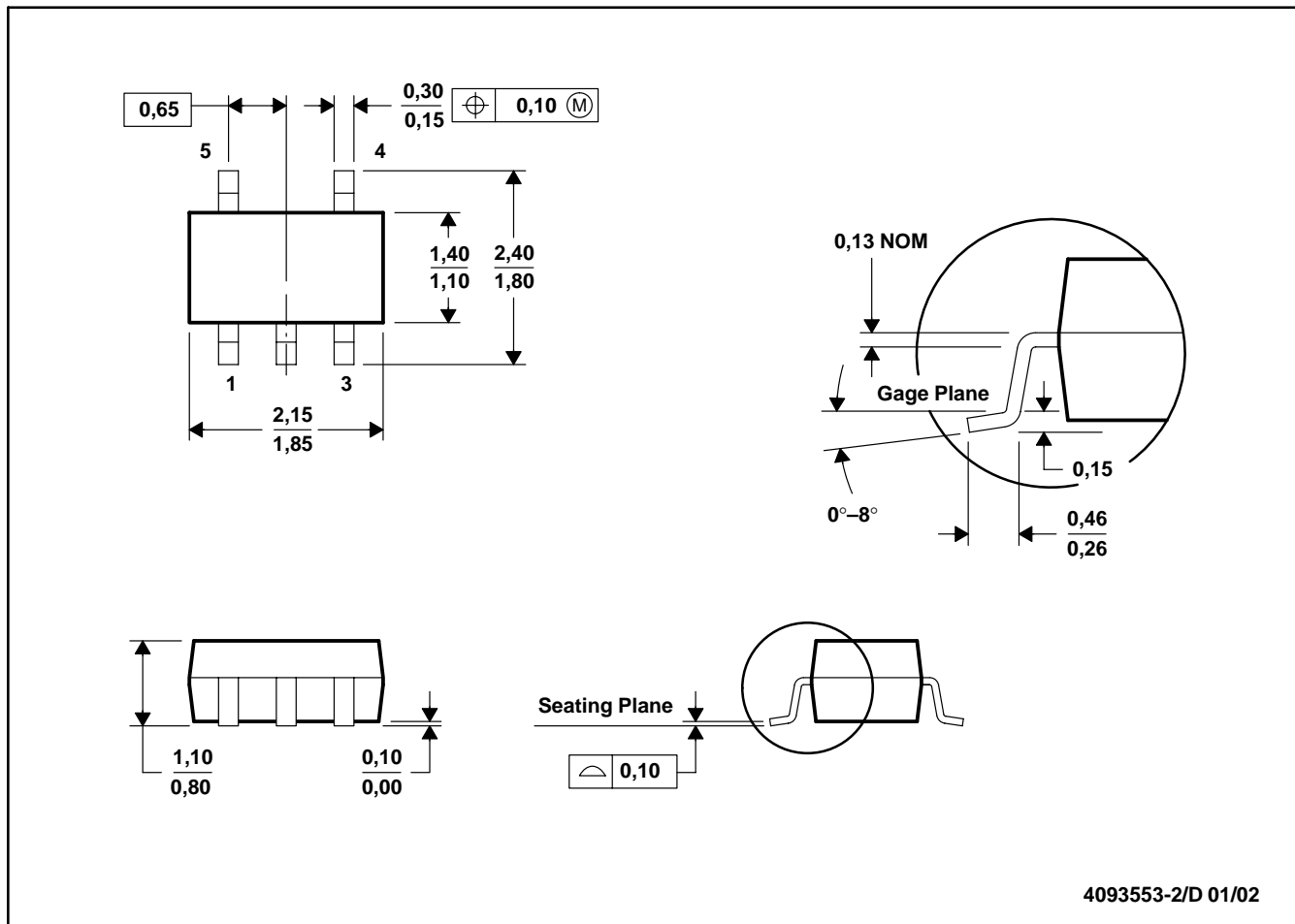
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-178 Variation AA.

DCK (R-PDSO-G5)

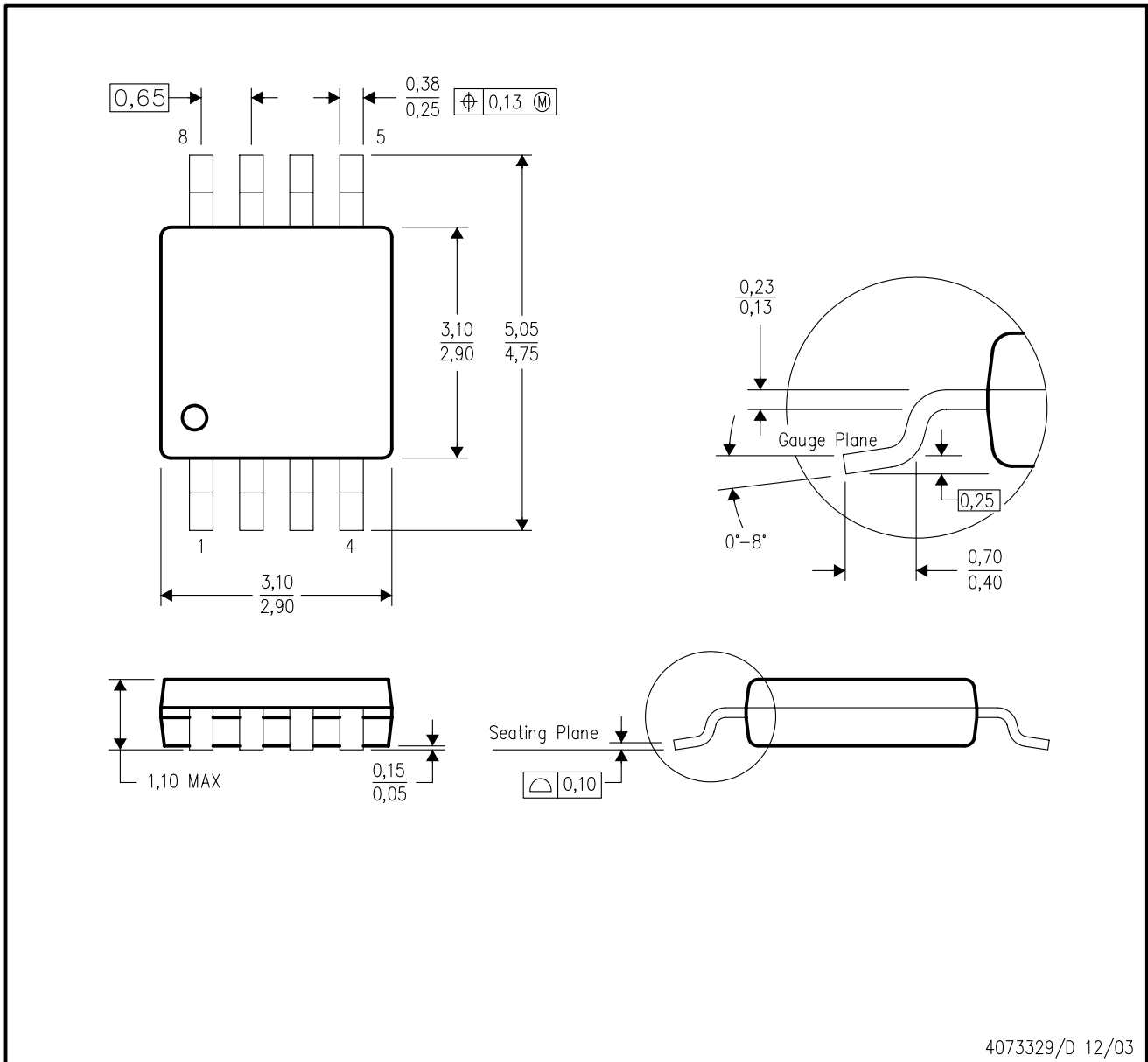
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion.
 D. Falls within JEDEC MO-203

DGK (S-PDSO-G8)

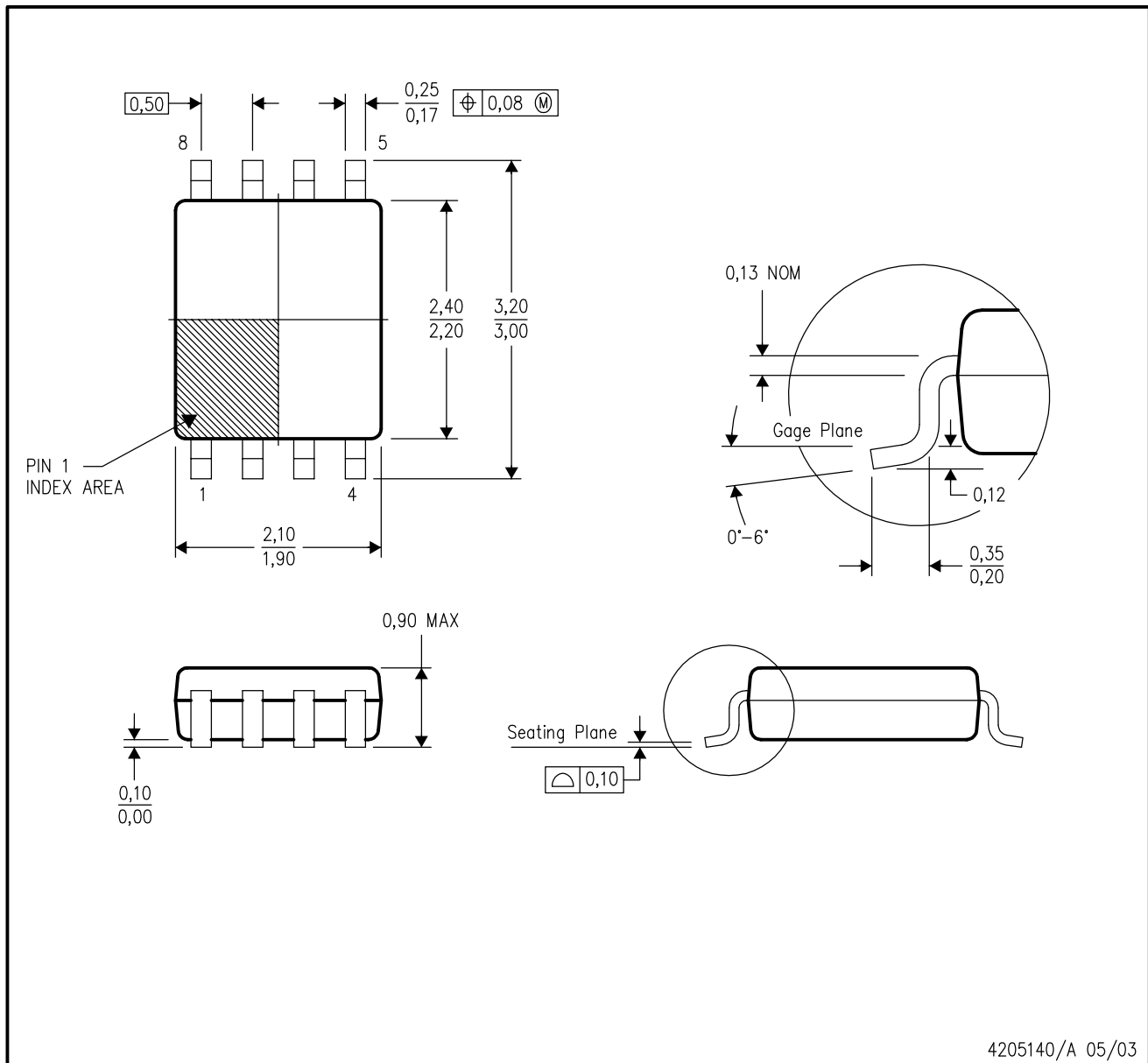
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-187 variation AA.

DDU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion.
 - Falls within JEDEC MO-187 variation CA.

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-012 variation AB.

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-012 variation AC.

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

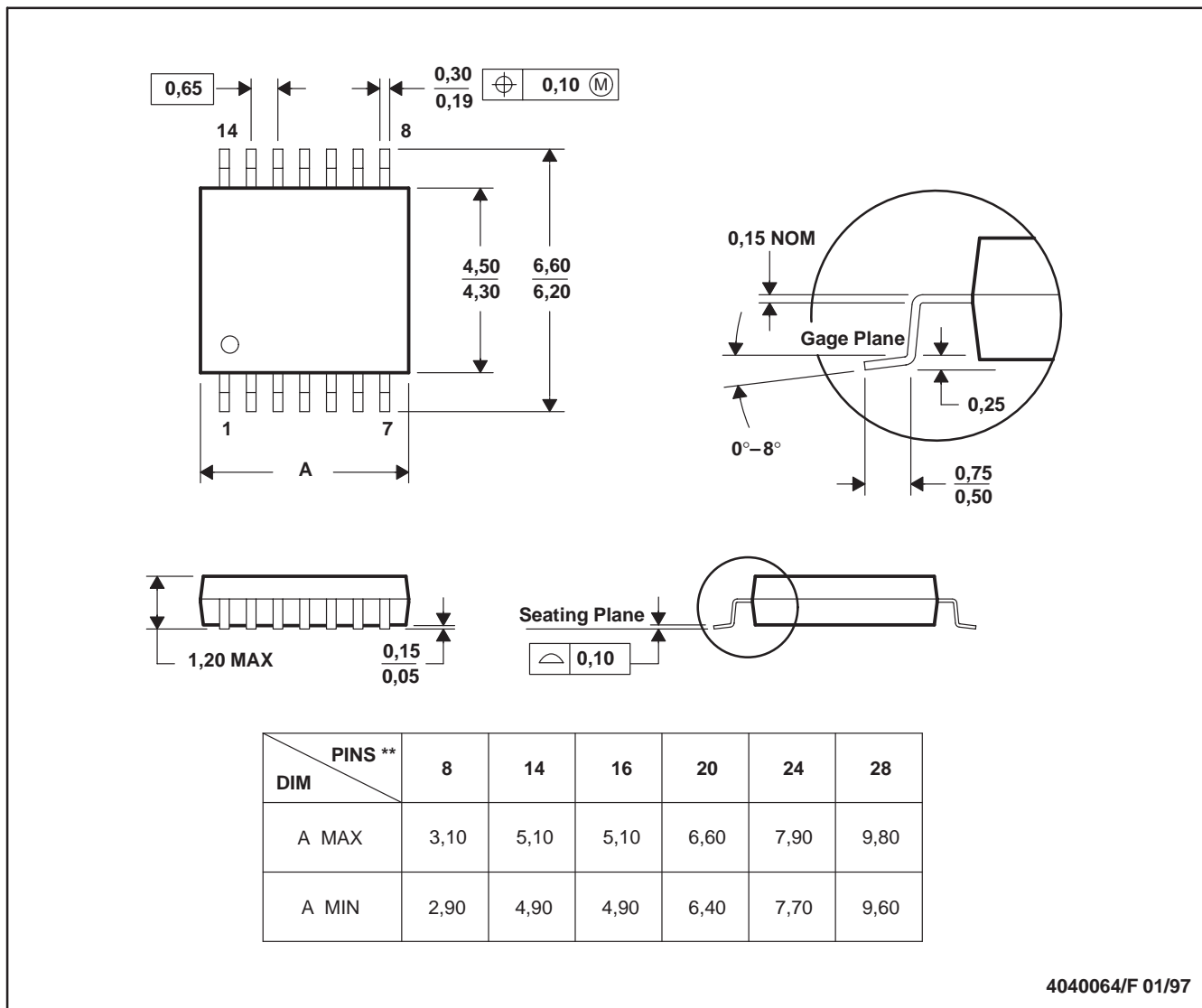


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-012 variation AA.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265